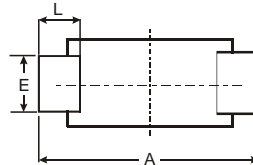
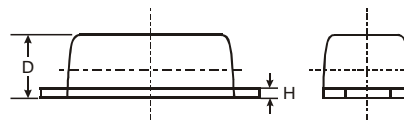
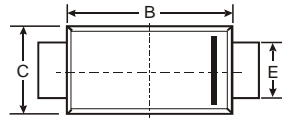
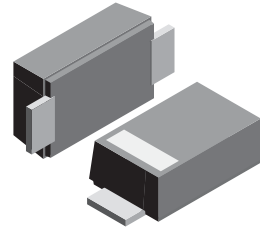


VOLTAGE RANGE: 50 - 600V
CURRENT: 1.0 A

Features

- Glass Passivated Die Construction
- Ideally Suited for Automatic Assembly
- Low Forward Voltage Drop, High Efficiency
- Low Power Loss
- Super-Fast Recovery Time
- Plastic Case Material has UL Flammability Classification Rating 94V-O



| SMAF | | | |
|----------------------|-------|------|------|
| Dim | Min | Max | Typ |
| A | 4.75 | 4.85 | 4.80 |
| B | 3.68 | 3.72 | 3.70 |
| C | 2.57 | 2.63 | 2.60 |
| D | 0.097 | 1.03 | 1.00 |
| E | 1.38 | 1.42 | 1.40 |
| H | 0.13 | 0.17 | 0.15 |
| L | 0.63 | 0.67 | 0.65 |
| All Dimensions in mm | | | |

Mechanical Data

- Case: SMAF, Molded Plastic
- Terminals: Solder Plated, Solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Mounting Position: Any
- Weight: 0.0018 ounce, 0.064 grams



Maximum Ratings and Electrical Characteristics T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

| Characteristic | Symbol | ER1AF | ER1BF | ER1CF | ER1DF | ER1EF | ER1GF | ER1JF | Unit |
|--|-----------------------------------|-------------|-------|-------|-------|-------|-------|-------|------|
| Peak Repetitive Reverse Voltage | V _{RRM} | 50 | 100 | 150 | 200 | 300 | 400 | 600 | V |
| Working Peak Reverse Voltage | V _{RWM} | | | | | | | | |
| DC Blocking Voltage | V _R | | | | | | | | |
| RMS Reverse Voltage | V _{R(RMS)} | 35 | 70 | 105 | 140 | 210 | 280 | 420 | V |
| Average Rectified Output Current @T _L = 100°C | I _O | 1.0 | | | | | | | A |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method) | I _{FSM} | 30 | | | | | | | A |
| Forward Voltage @I _F = 1.0A | V _{FM} | 0.95 | | | | 1.25 | | 1.7 | V |
| Peak Reverse Current @T _A = 25°C At Rated DC Blocking Voltage @T _A = 100°C | I _{RM} | | | | | 5.0 | | | μA |
| | | | | | | 500 | | | |
| Reverse Recovery Time (Note 1) | t _{rr} | | | | | 35 | | | nS |
| Typical Junction Capacitance (Note 2) | C _j | | | | | 10 | | | pF |
| Typical Thermal Resistance (Note 3) | R _{θJL} | | | | | 34 | | | K/W |
| Operating and Storage Temperature Range | T _j , T _{STG} | -65 to +150 | | | | | | | °C |

Note: 1. Measured with I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A,
 2. Measured at 1.0 MHz and applied reverse voltage of 4.0 V DC.
 3. Mounted on P.C. Board with 8.0mm² land area.

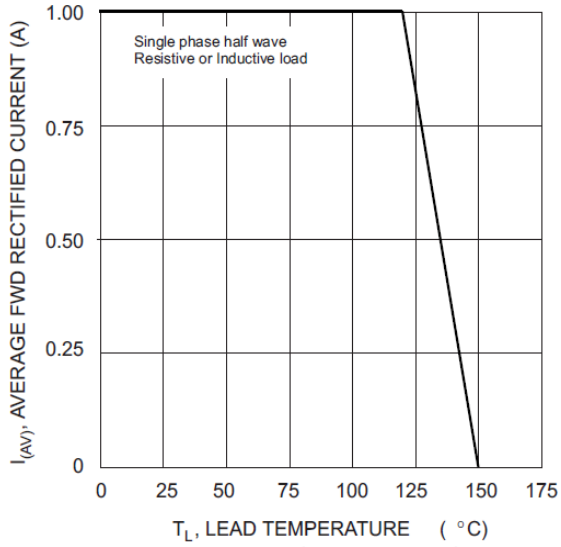


Fig. 1 Forward Current Derating Curve

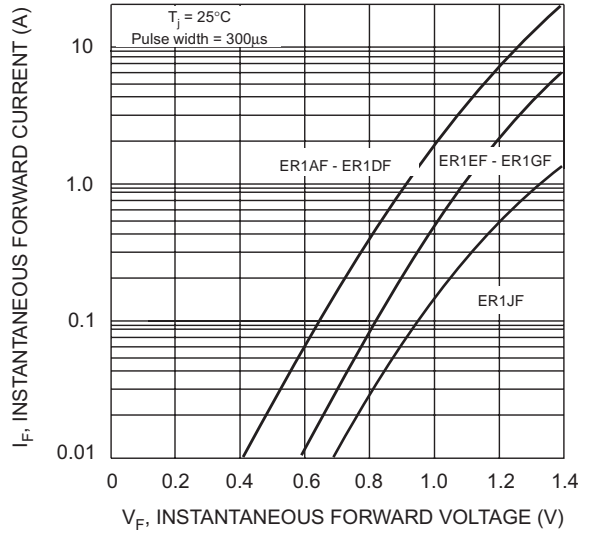


Fig. 2 Typical Forward Characteristics

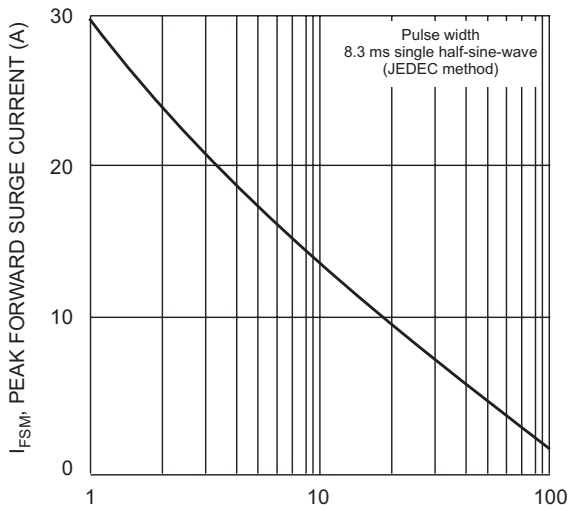


Fig. 3 Peak Forward Surge Current

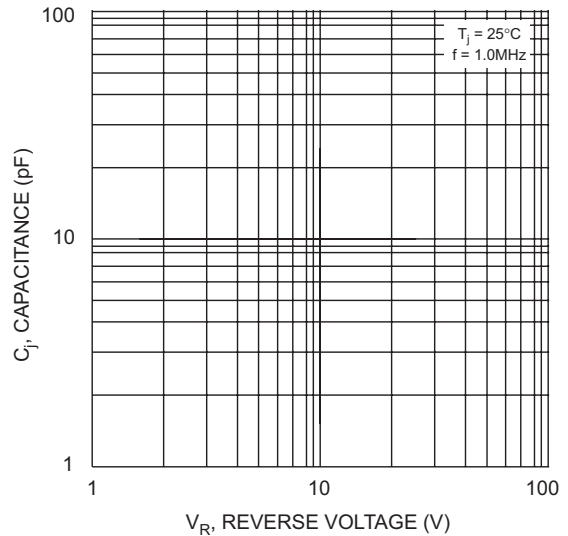
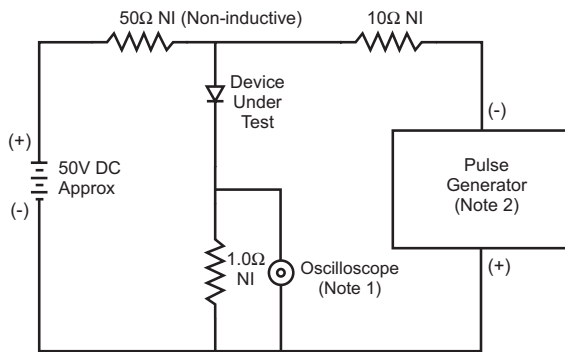
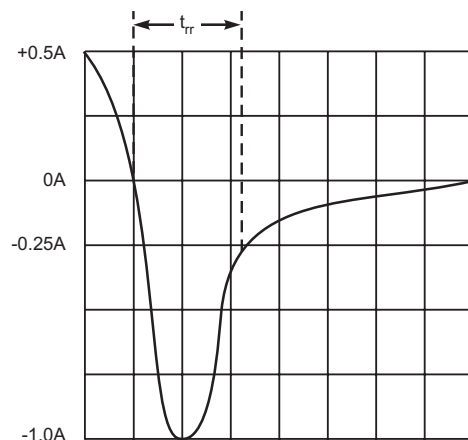


Fig. 4 Typical Junction Capacitance



- Notes:
1. Rise Time = 7.0ns max. Input Impedance = 1.0MΩ, 22pF.
 2. Rise Time = 10ns max. Input Impedance = 50Ω.



Set time base for 5/10ns/cm

Fig. 5 Reverse Recovery Time Characteristic and Test Circuit